

# **Power MOSFET** 200 mAmps, 50 Volts N-Channel SOT-23

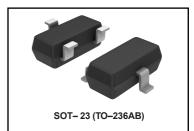
Typical applications are dc–dc converters, power management in portable and battery–powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low Threshold Voltage (V <sub>GS(th)</sub>: 0.5V...1.5V) makes it ideal for low voltage applications
- Miniature SOT-23 Surface Mount Package saves board space
- Pb–Free Package May be Available. The G–Suffix Denotes a Pb–Free Lead Finish
- We declare that the material of product are Halogen Free and compliance with RoHS requirements.

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{\text{DSS}}$	50	Vdc
Gate-to-Source Voltage - Continuous	$V_{GS}$	± 20	Vdc
Drain Current – Continuous @ T <sub>A</sub> = 25°C – Pulsed Drain Current (t <sub>p</sub> ≤ 10 μs)	I <sub>D</sub> I <sub>DM</sub>	200 800	mA
Total Power Dissipation @ T <sub>A</sub> = 25°C	PD	225	mW
Operating and Storage Temperature Range	$T_{J_{i}}T_{stg}$	– 55 to 150	°C
Thermal Resistance – Junction-to-Ambient	$R_{ extsf{ heta}JA}$	556	°C/W
Maximum Lead Temperature for Soldering Purposes, for 10 seconds	TL	260	°C

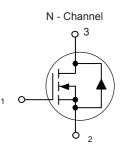
#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

## **BSS138**

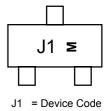


## 200 mAMPS 50 VOLTS

## R <sub>DS(on)</sub> = 3.5 $\Omega$



#### MARKING DIAGRAM & PIN ASSIGNMENT



M = Month Code

#### **ORDERING INFORMATION**

Device	Package	Shipping	
BSS138 T/R	SOT-23	3000 Tape & Reel	
BSS138-13 T/R	SOT-23	10000 Tape & Reel	



### **BSS138**

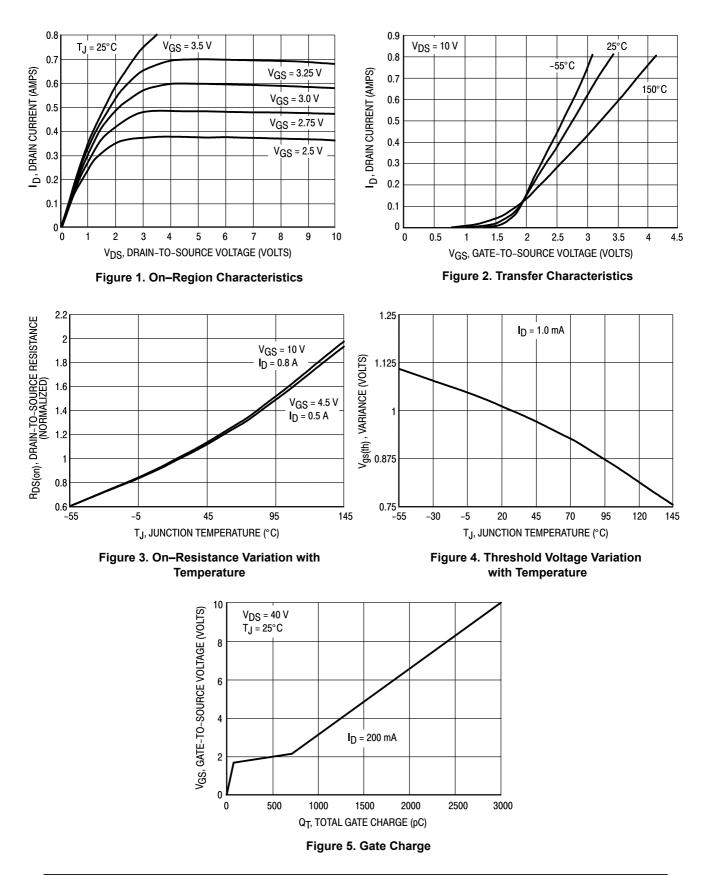
ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic			Min	Тур	Мах	Unit
OFF CHARACTERISTICS		•				
Drain–to–Source Breakdown Voltage (V <sub>GS</sub> = 0 Vdc, I <sub>D</sub> = 250 μAdc)		V <sub>(BR)DSS</sub>	50	-	-	Vdc
Zero Gate Voltage Drain Current $(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$ $(V_{DS} = 50 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$		I <sub>DSS</sub>			0.1 0.5	µAdc
Gate-Source Leakage Current (V <sub>GS</sub>	Gate–Source Leakage Current ( $V_{GS}$ = ± 20 Vdc, $V_{DS}$ = 0 Vdc)		-	-	±0.1	μAdc
ON CHARACTERISTICS (Note 1.)						
Gate–Source Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 1.0$ mAdc)		V <sub>GS(th)</sub>	0.5	-	1.5	Vdc
Static Drain–to–Source On–Resistance $(V_{GS} = 2.75 \text{ Vdc}, I_D < 200 \text{ mAdc}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$ $(V_{GS} = 5.0 \text{ Vdc}, I_D = 200 \text{ mAdc})$		r <sub>DS(on)</sub>	_ _	5.6 -	10 3.5	Ohms
Forward Transconductance $(V_{DS} = 25 \text{ Vdc}, I_D = 200 \text{ mAdc}, f = 1.0 \text{ kHz})$		9 <sub>fs</sub>	100	-	-	mmhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V <sub>DS</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>iss</sub>	-	40	50	pF
Output Capacitance	(V <sub>DS</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>oss</sub>	-	12	25	
Transfer Capacitance	(V <sub>DG</sub> = 25 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>rss</sub>	-	3.5	5.0	
SWITCHING CHARACTERISTICS (M	Note 2.)	•				
Turn–On Delay Time		t <sub>d(on)</sub>	-	-	20	ns
Turn–Off Delay Time	$(V_{DD} = 30 \text{ Vdc}, I_D = 0.2 \text{ Adc},)$	t <sub>d(off)</sub>	-	-	20	

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.



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### **TYPICAL ELECTRICAL CHARACTERISTICS**



 $\mathsf{RDS}(\mathsf{on})$  , <code>DRAIN-TO-SOURCE</code> <code>RESISTANCE</code> (OHMS) 10 RDS(on) , DRAIN-TO-SOURCE RESISTANCE (OHMS) 8 V<sub>GS</sub> = 2.5 V V<sub>GS</sub> = 2.75 V 9 7 150°C 8 150°C 6 7 5 6 5 25°C 4 25°C 4 3 -55°C 3 2 -55°C 2 1 0 1⊾ 0 0.05 0.15 0.2 0.25 0.05 0.15 0.2 0.25 0.1 0.1 ID, DRAIN CURRENT (AMPS) ID, DRAIN CURRENT (AMPS) Figure 7. On–Resistance versus Drain Current Figure 6. On-Resistance versus Drain Current RDS(on) , DRAIN-TO-SOURCE RESISTANCE (OHMS) RDS(on), DRAIN-TO-SOURCE RESISTANCE (OHMS) 4.5 6 V<sub>GS</sub> = 4.5 V V<sub>GS</sub> = 10 V 5.5 150<sup>°</sup>C 150°C 5 4.5 3.5 4 3 3.5 2.5 25°C 3 25°C 2.5 2 2 -55°C -55°C 1.5 1.5 1 0.05 0.1 0.15 0.2 0.25 0.3 0.35 0.4 0.45 0.5 0 0.05 0.1 0 0.15 0.2 0.25 0.3 0.35 0.4 0.45 0.5 ID, DRAIN CURRENT (AMPS) ID, DRAIN CURRENT (AMPS)

## TYPICAL ELECTRICAL CHARACTERISTICS

Figure 8. On–Resistance versus Drain Current

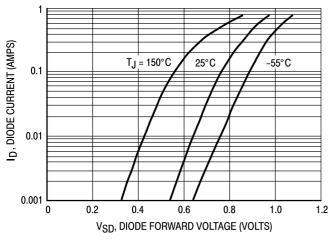


Figure 10. Body Diode Forward Voltage

Figure 9. On-Resistance versus Drain Current

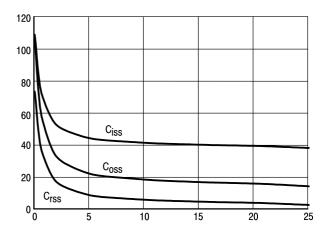


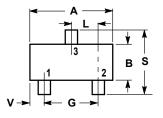
Figure 11. Capacitance

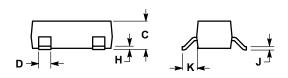
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## SOT-23





#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS		
	MIN	MAX	MIN	MAX	
Α	0.1102	0.1197	2.80	3.04	
В	0.0472	0.0551	1.20	1.40	
С	0.0350	0.0440	0.89	1.11	
D	0.0150	0.0200	0.37	0.50	
G	0.0701	0.0807	1.78	2.04	
Н	0.0005	0.0040	0.013	0.100	
J	0.0034	0.0070	0.085	0.177	
к	0.0140	0.0285	0.35	0.69	
L	0.0350	0.0401	0.89	1.02	
S	0.0830	0.1039	2.10	2.64	
v	0.0177	0.0236	0.45	0.60	



